

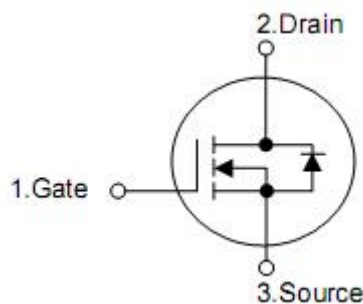
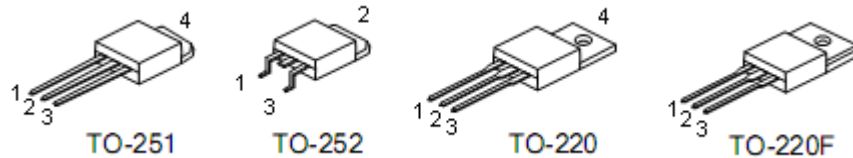
1. Description

This Power MOSFET is produced using KIA advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

2. Features

- n $R_{DS(on)}=2.5\Omega$ @ $V_{GS}=10V$
- n Low gate charge (typical 16nC)
- n High ruggedness
- n Fast switching
- n 100% avalanche tested
- n Improved dv/dt capability

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

4. Absolute maximum ratings

(T_C=25°C , unless otherwise noted)

Parameter	Symbol	Rating				Units	
		TO251	TO252	TO220	TO220F		
Drain-source voltage	V _{DSS}	650				V	
Drain current continuous	I _D	T _C =25°C	3.0	3.0	4.0	4.0*	A
		T _C =100°C	1.8	1.8	2.4	2.4*	A
Drain current pulsed (note1)	I _{DM}	12	12	16	16*	A	
Gate-source voltage	V _{GSS}	±30				V	
Single Pulse avalanche energy (note2)	E _{AS}	210	210	180	180	mJ	
Repetitive avalanche energy (note1)	E _{AR}	5.8	5.8	10	10	mJ	
Peak diode recovery dv/dt (note3)	dv/dt	4.5				V/ns	
Power dissipation	P _D	T _C =25°C	58	58	104	34	W
		Derate above 25°C	0.46	0.46	0.83	0.27	W/°C
Operating and storage temperature range	T _J , T _{STG}	-55~+150				°C	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T _L	300				°C	

*Drain current limited by maximum junction temperature.

5. Thermal characteristics

Parameter	Symbol	TO251	TO252	TO220	TO220F	Unit
Thermal resistance junction-case	R _{thJC}	2.16	2.16	1.2	3.65	°C/W
Thermal resistance, case-to-sink typ.	R _{thJS}	50	50	0.5	0.5	
Thermal resistance junction-ambient	R _{thJA}	110	110	62.5	62.5	

6. Electrical characteristics

($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Off characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	650	-	-	V
Breakdown voltage temperature coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D=250\mu A$, Referenced to 25°C	-	0.65	-	$V/^{\circ}\text{C}$
Zero gate voltage drain current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$	-	-	1	μA
		$V_{DS}=520V, T_C=125^{\circ}\text{C}$	-	-	10	μA
Gate-body leakage current	Forward	$V_{GS}=30V, V_{DS}=0V$	-	-	100	nA
	Reverse	$V_{GS}=-30V, V_{DS}=0V$	-	-	-100	nA
On characteristics						
Gate threshold voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V
Static drain-source on-resistance	$R_{DS(ON)}$	$V_{GS}=10V$, $I_D=1.5A$ (TO251, TO252) $I_D=2.0A$ (TO220, TO220F)	-	2.5	3.0	Ω
Dynamic characteristics						
Input capacitance	C_{ISS}	$V_{DS}=25V, V_{GS}=0V$, $f=1\text{MHz}$	-	560	-	pF
Output capacitance	C_{OSS}		-	55	-	pF
Reverse transfer capacitance	C_{RSS}		-	7	-	pF
Switching characteristics						
Turn-on delay time	$t_{D(ON)}$	$V_{DD}=300V, I_D=4.5A$ (TO251, TO252), $V_{DD}=325V, I_D=4.0A$ (TO220, TO220F) $R_G=25\Omega$, (note4,5)	-	10	-	ns
Rise time	t_R		-	40	-	ns
Turn-off delay time	$t_{D(OFF)}$		-	40	-	ns
Fall time	t_F		-	50	-	ns
Total gate charge	Q_G	$V_{DS}=480V, I_D=4.5A$ (TO251, TO252)	-	16	-	nC
Gate-source charge	Q_{GS}	$V_{DS}=520V, I_D=4.0A$ (TO220, TO220F)	-	2.5	-	nC
Gate-drain charge	Q_{GD}	$V_{GS}=10V$ (note4,5)	-	6.5	-	nC
Drain-source diode characteristics						
Continuous drain-source current	I_S	TO251, TO252	-	-	3.0	A
		TO220, TO220F	-	-	4.0	
Pulsed drain-source current	I_{SM}	TO251, TO252	-	-	12	A
		TO220, TO220F	-	-	16	
Drain-source diode forward voltage	V_{SD}	$V_{GS}=0V$, $I_S=3.0A$ (TO251, TO252) $I_S=4.0A$ (TO220, TO220F)	-	-	1.4	V
Reverse recovery time	t_{RR}	$V_{GS}=0V, di_F/dt=100A/\mu s$ $I_S=4.5A$, (TO251, TO252)	-	300	-	ns
Reverse recovery charge	Q_{RR}	$I_S=4.0A$ (TO220, TO220F) (note 4)	-	2.0	-	μC

Note:1. Repetitive rating: pulse width limited by maximum junction temperature

2. $I_{AS}=4.5A, V_{DD}=50V$, (TO251, TO252), $I_{AS}=4.0A, V_{DD}=25V$ (TO220, TO220F), $R_G=25\Omega$, starting $T_J=25^{\circ}\text{C}$

3. $I_{SD}\leq 4.5A$, (TO251, TO252), $I_{SD}\leq 4.0A$ (TO220, TO220F), $di/dt \leq 200A/\mu s$, $V_{DD}\leq BV_{DSS}$, starting $T_J=25^{\circ}\text{C}$

4. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

5. Essentially independent of operating temperature

7. Test circuits and waveforms

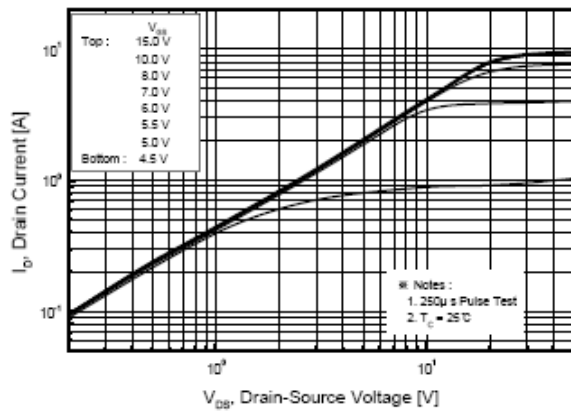


Figure 1. On-Region Characteristics

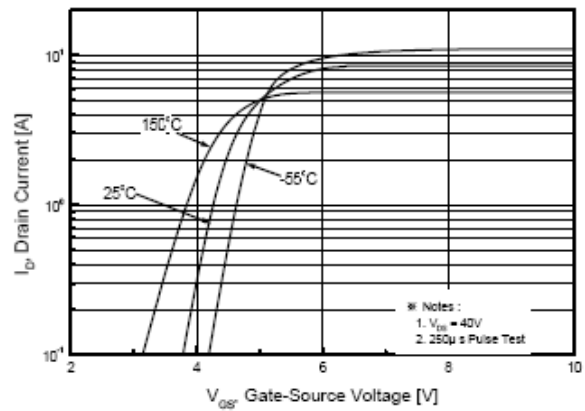


Figure 2. Transfer Characteristics

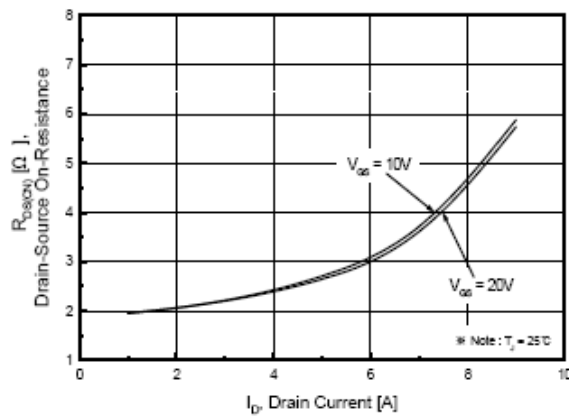


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

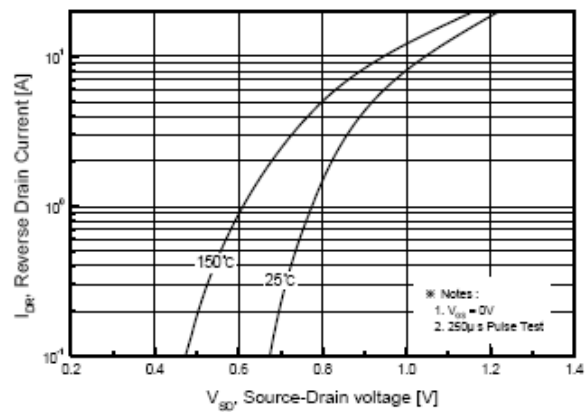


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

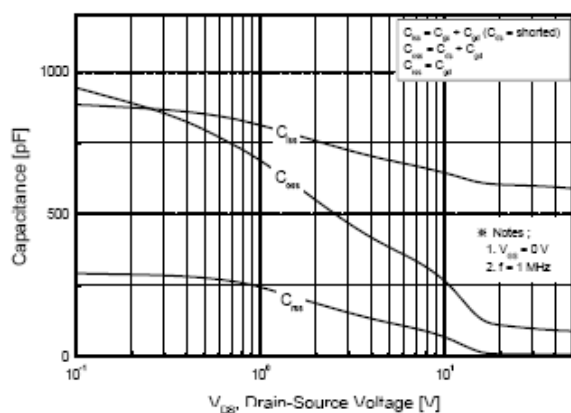


Figure 5. Capacitance Characteristics

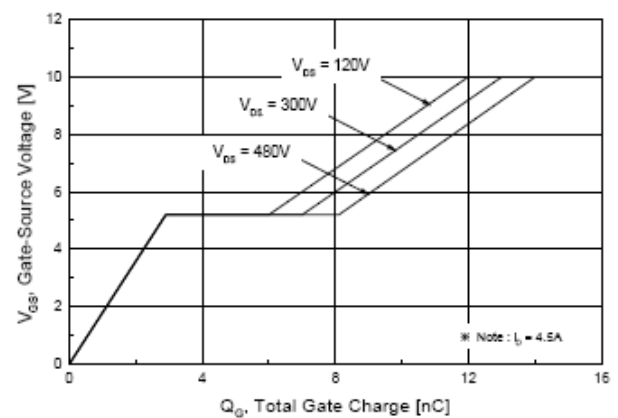


Figure 6. Gate Charge Characteristics

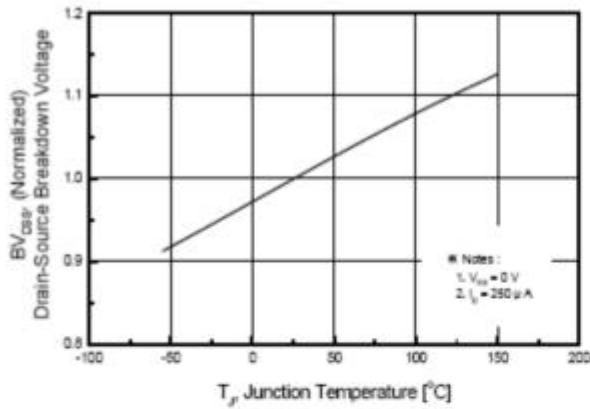


Figure 7. Breakdown Voltage Variation vs Temperature

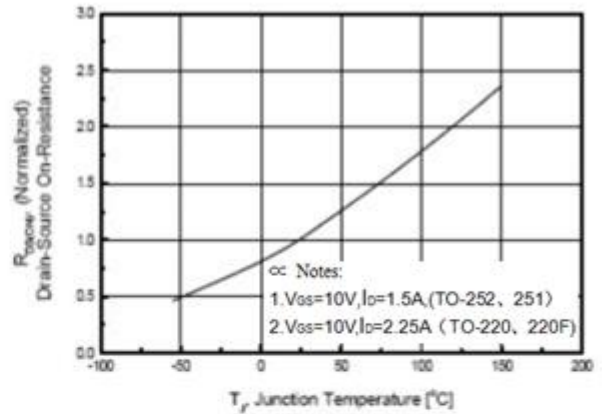


Figure 8. On-Resistance Variation vs Temperature

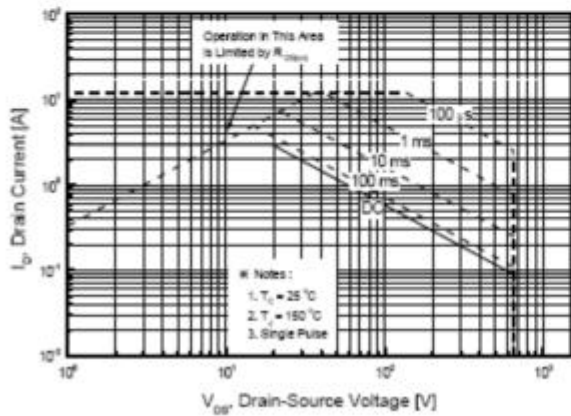


Figure 9. Maximum Safe Operating Area

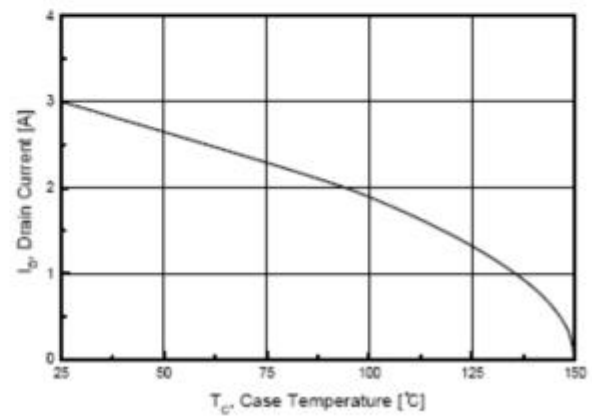


Figure 10. Maximum Drain Current vs Case Temperature

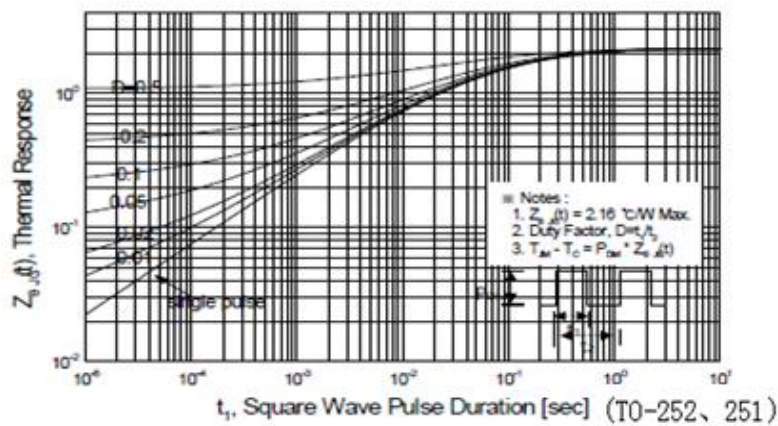


Figure 11. Transient Thermal Response Curve

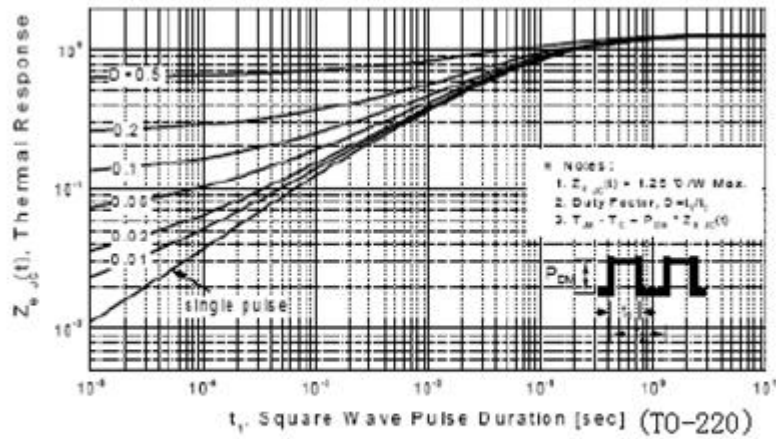


Figure 11-1. Transient Thermal Response Curve

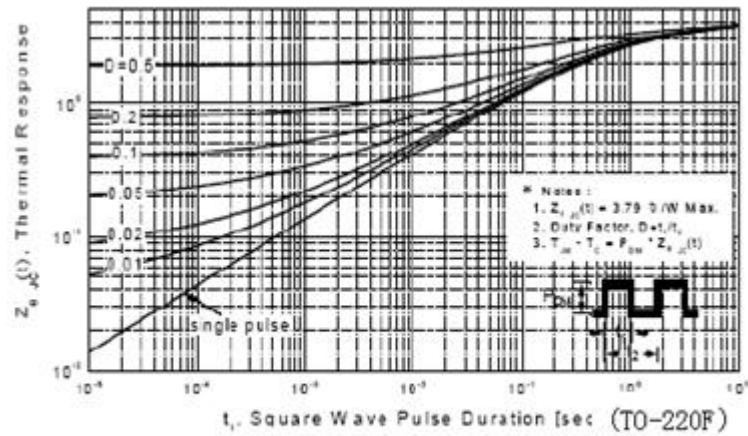


Figure 11-2. Transient Thermal Response Curve

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